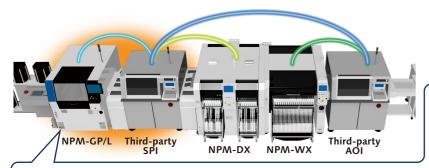
Line Solution

The inclusion of AOI in M2M system to realize high-quality production.

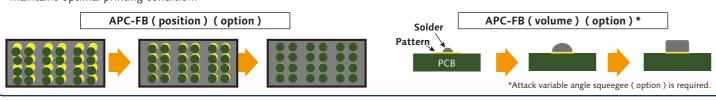


Printing condition optimization control (APC-5M) (option)

By changing each printing parameter condition, such as printing pressure, squeegee speed and snap-off rate, based on result data from SPI, it helps reach and maintains optimal printing condition (volume).

●APC-FB function

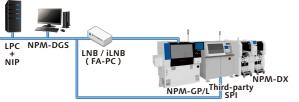
Based on result data from SPI, it corrects printing positions and volume. There are two correction options available: position correction and volume correction. Since APC-FB (volume) controls solder volume by changing the squeegee angle, it helps reach smoothly and maintains optimal printing condition.

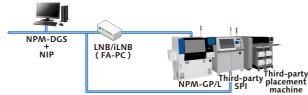


■System configuration

NPM-GP/L + Panasonic placement machine + APC-5M + APC-FB

NPM-GP/L + Third-party placement machine + APC-5M + APC-FB





NIP: APC-5M control software (NPM-GP/L-specific) + Third-party interface software, LPC: APC-5M control software (mounter-specific), LNB / iLNB : Line network box , NPM-DGS : Data creation system

Model ID	NPM-GP/L
Model No.	NM-EJP2B
PCB dimensions *1	L 50 mm × W 50 mm to L 510 mm × W 510 mm
PCB exchange time *2	12.0 s including transport , PCB positioning , PCB recognition , printing , each cleaning operation (When PCB = L 250 mm × W 150 mm)
Repeatability	2 Cpk ± 3.8 μm ± 3 σ (Panasonic-specified condition)
Printing accuracy	2 Cpk ±15.0 μm ± 6σ (Panasonic-specified condition) *CeTaQ measuring machine used
Screen frame dimensions *3	L 736 mm \times 736 mm \times L 750 mm \times 750 mm \times L 650 mm \times 550 mm \times L 600 mm \times 550 mm L 550 mm \times 650 mm \times L 584 mm \times 584 mm \times 584 mm \times 584 mm \times 736 mm
Electric source *4	Single-phase AC 200 V ±10 V / AC 220 V ±10 V / AC 230 V ±10 V / AC 240 V ±10 V (Taps can be changed), Max.3.3 kVA
Pneumatic source	0.5 Mpa , 30 L / min (A.N.R.) (motor vacuum specs) , 400 L / min (A.N.R.) (ejector vacuum specs)
Dimensions *5	W 1 580 mm × D 1 800 mm × H 1 500 mm
Mass *6	1 750 kg

Please refer to the specification booklet for details

- *1: When"Paper-free Wiping Unit," "automatic support pin exchange"or "Attack variable angle squeegee"has been selected , the limit of the maximum PCB width changes. For details , refer to 'Specification manual."
- *2 : The PCB replacement time differs depending on downstream and upstream machine types , PCB size, the use of PCB holders, etc.
- *3 : For Metal Mask specs , refer to Specification manual.
- *4: Blowers and vacuum pumps (option) included. *5: Signal tower and touch panel excluded.
- *6 : When the machine is fully optioned.

Safety Cautions

- Please read the User's Manual carefully to familiarize yourself with safe and effective usage procedures.
- ●To ensure safety when using this equipment, all work should be performed according to that as stated in the supplied Operating Instructions. Read your operating instruction manual thoroughly.

Panasonic Group products are built with the environment in mind.



Inquiries.

Panasonic Connect Co., Ltd.

Process Automation Business Division

3-1-1 Inazu-cho, Toyonaka City, Osaka 561-0854, Japan

All data as of April 1, 2024

Ver.April 1, 2024

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Changes in specifications and appearance may be made without notice for product improvement
 Please contact us via our website at https://industrial.panasonic.com/ww/r/fw



Electronics Assembly System

Modular Placement Machine

Catalogue

2024

Model ID

NPM-GP/L Model No. NM-EJP2B



NPM G



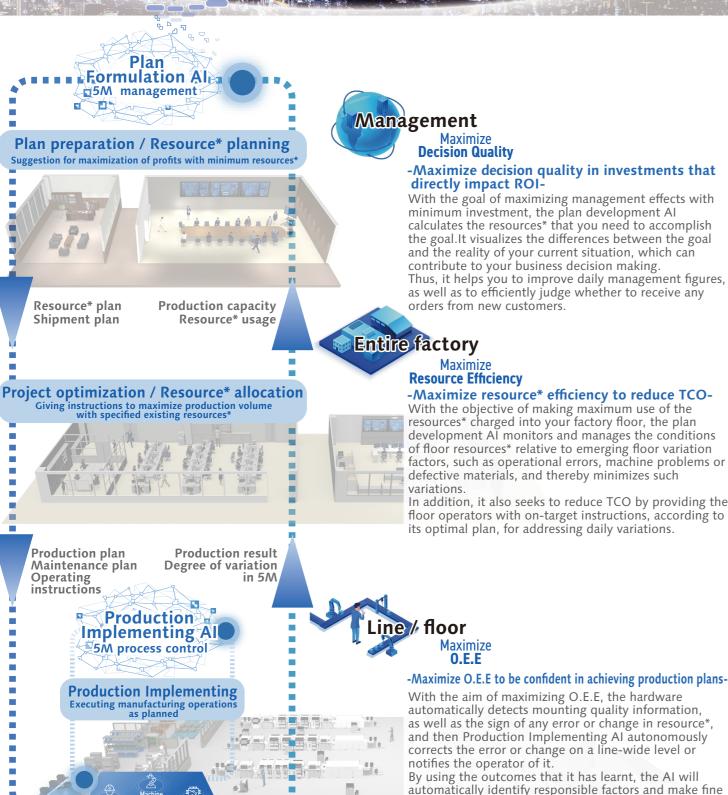
*It may not conform to Machinery Directive and EMC Directive in case of optional configuration and custom-made specification

"Autonomous Factory" Concept

A factory that immediately responds to every situation and continues to evolve autonomously

Ensuring the production of non-defective items through the integrated control of autonomous uninterrupted mounting lines and floors independent of any human intervention and judgment

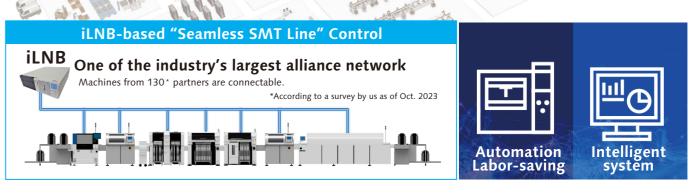


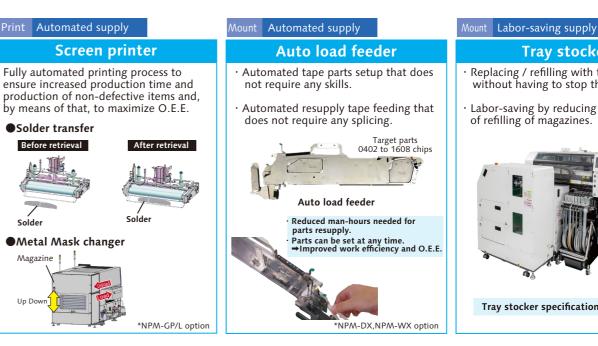


tuning of equipment, accordingly, which have so far belonged to the realm of Takumi know-how alone.

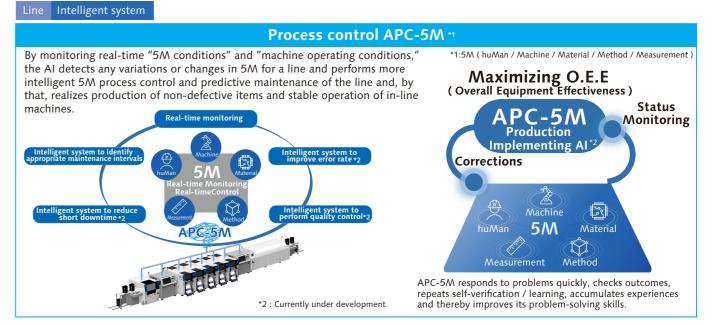
Resource*: Human / Machine / Material

Automation / Labor-saving Solution + Intelligent system Solution to Achieve Manufacturing That Is Further in Line with Production Plan









Realization of Autonomous Mounting Line

NPM-GP/L Maximizing OEE through Replacement of Skills by Automation / Line Solutions

Features

Increased production time

- (1) Reduces machine availability losses through automation of operations required for model changeover.
- (2) Reduces machine performance losses through automation of operations involved in production.
- (3) Increases production time by monitoring machine conditions and thereby performing maintenance at right times.



Maintenance of printing quality at a consistently high level

Reduces losses due to defective items through various functions that actualizes consistently high-quality. printing capable of responding to any changes in 5M.



Support for line solution

Realizes high-quality line production through M2M.

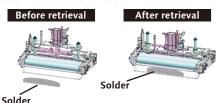
Increased production time

Automated model changeover

Any operations required for model changeover are automated.

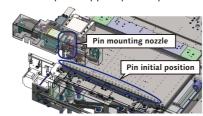
Solder transfer (option)

It automatically retrieves on-Metal Mask solder after printing and transfers the solder to the Metal Mask for next model



Support pin automatic exchange (option)

During model changeover, it automatically retrieves and puts support pins in place.



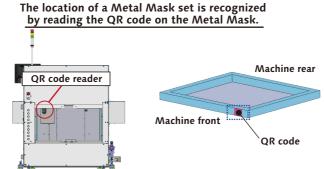
Metal Mask changer (option)

A magazine that can be stocked up with up to 10 Metal Masks is installed at the rear of machine. Upon completion of the production of a model, it automatically put the Metal Mask used for the model in a magazine and sets the Metal Mask for next model on the

In-magazine Metal Mask can be loaded or unloaded even during production.





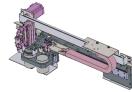


Automatic operation in manufacturing

Any operations required during production are automated.

Perforated pot type automatic solder supply (option)

It automatically supply solder through the hole in the undersurface of solder pot. Used in combination with remaining detection sensor, it can keep the right amount of solder on Metal Mask.



Paper-free Wiping Unit (option)

It is cleaning free of any cleaning paper and solvent. Thus, it can contribute to paper / solvent reduction.



Morene Block (option)

Comes in contact with the Metal Mask using magnet repellence to prevent solder side leakage during printing. Simple construction for easy cleaning.



Machine condition monitoring (preventive / predictive maintenance)

It monitors the machine conditions in real time and by that optimizes the timing of maintenance and increases production time.



High-quality printing

printing quality of warped PCB.

Various functions are ready for use to achieve high-quality printing.

New operation panel

- 1 A large-sized panel (15-inch) introduced to increase ease of use and visibility.
- 2 Screen configuration reviewed (a reduction in the number of screens) to decrease the screen handling time required.

Curved edge high filling pressure

squeegee (option)

An increase in size from 8.4 - to 15-inch



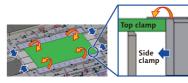
it is easy to handle.

Typical



Curved edge high filling





(option)

Top / side clamper (movable type)

Pressing down on PCB edge faces increases

Either PCB upper or side face can be selected

(option)

Material verification

A metal squeegee of which the curved blade
It makes verifications of Metal Mask, squeegee, Printing transcription is improved through the edge can enhance its filling performance. support block and solder and by means of As is the case with typical metal squeegees, that prevents wrong materials from being set. When a verification error or nonverification

occurs, it stops the machine Metal Mask



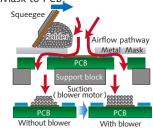
Attack angle variable squeegee (option)

The attack angle can be set at any angle in the 45 to 70 degrees in 1 degree increments. When it is used in conjunction with the APC-FB (volume) function, the attack angle can be changed automatically.



PCB pickup blower (switch type) (option)

use of blower to create airflow pathways from Metal Mask to PCB,



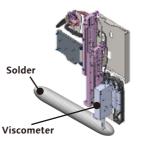
Stable production

Support

APC-5M helps keep production stable by monitoring material conditions and automatically changing machine parameters.

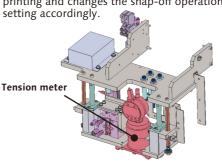
Solder viscosity feedback (option)

It measures and controls the viscosity of on-Metal Mask solder and by that keeps the viscosity at a proper level.



Metal Mask tension feedback (option)

It measures Metal Mask tension prior to printing and changes the snap-off operation



Solvent discharge feedback (option)

It monitors the amount of solvent discharge during wet cleaning and thereby keeps the

